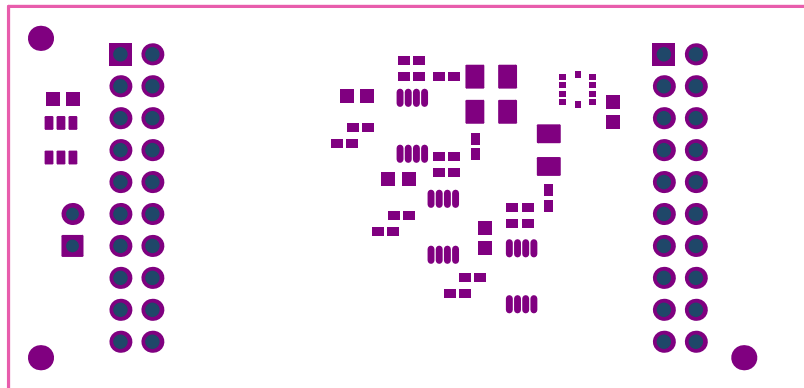
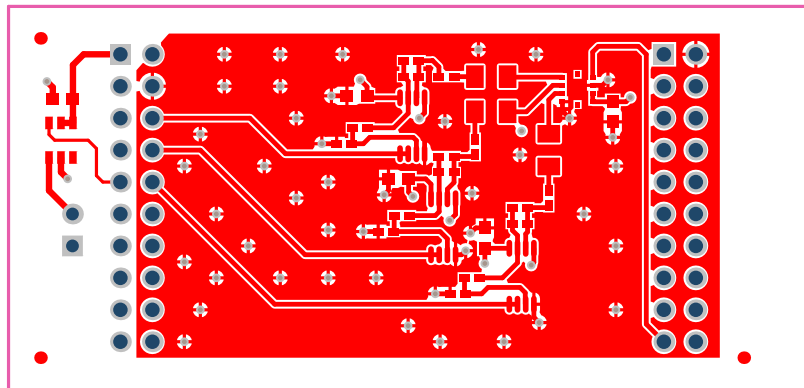


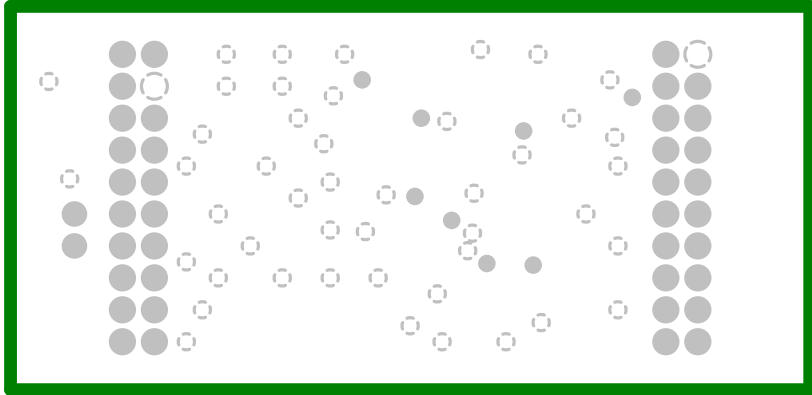
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01575	REV: A0	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-01575		
PLOT NAME = Top Overlay	GENERATED : 1/25/2018	9:07:44 AM	TEXAS INSTRUMENTS



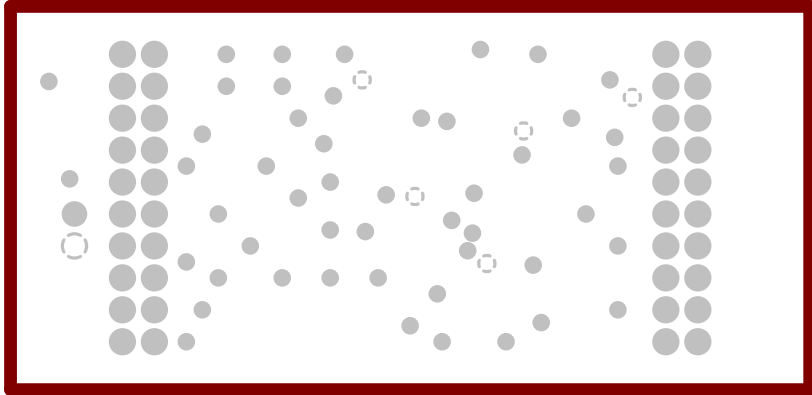
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01575	REV: A0	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-01575		
PLOT NAME = Top Solder Mask	GENERATED : 1/25/2018 9:07:44 AM	TEXAS INSTRUMENTS	



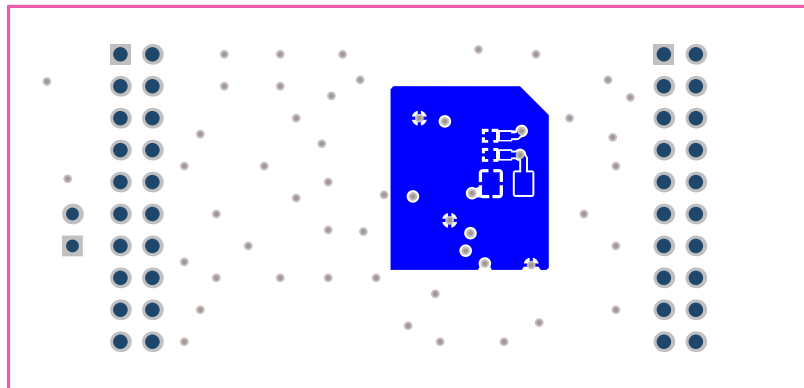
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01575	REV: A0	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-01575		
PLOT NAME = Top Layer	GENERATED : 1/25/2018 9:07:44 AM	TEXAS INSTRUMENTS	



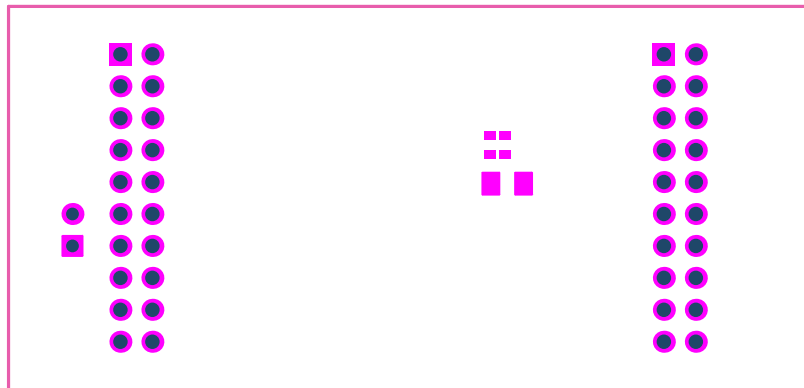
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01575	REV: A0	SUN REV: Not In VersionControl
LAYER NAME = Internal Plane 1	TID #: TIDA-01575		
PLOT NAME = Internal Plane 1	GENERATED : 1/25/2018	9:07:44 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01575	REV: A0	SUN REV: Not In VersionControl
LAYER NAME = Internal Plane 2	TID #: TIDA-01575		
PLOT NAME = Internal Plane 2	GENERATED : 1/25/2018 9:07:44 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01575	REV: A0	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-01575		
PLOT NAME = Bottom Layer	GENERATED : 1/25/2018 9:07:44 AM	TEXAS INSTRUMENTS	

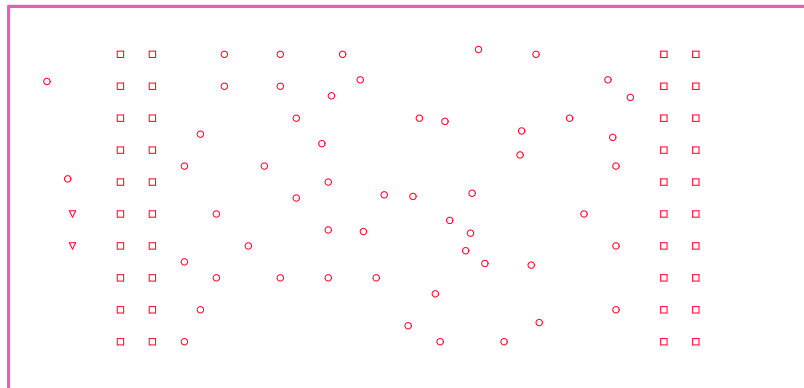


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01575	REV: A0	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-01575		
PLOT NAME = Bottom Solder Mask	GENERATED : 1/25/2018 9:07:44 AM	TEXAS INSTRUMENTS	

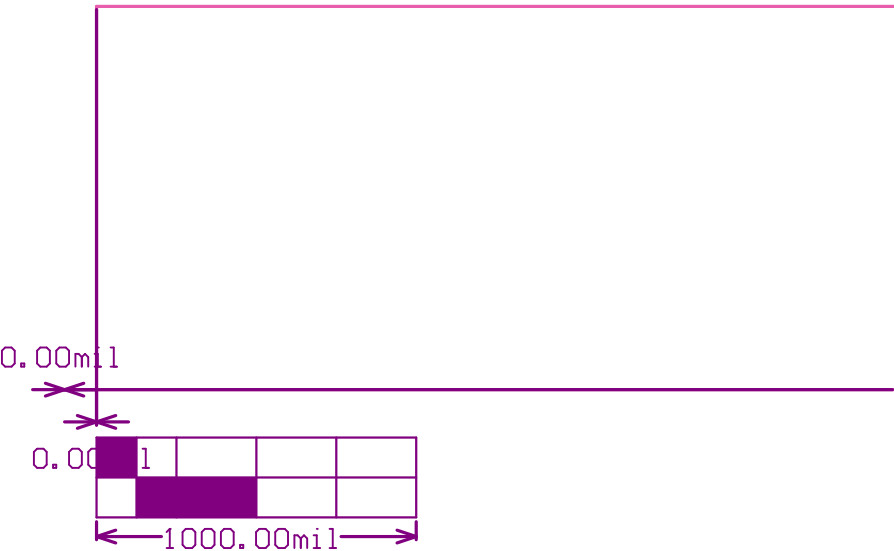


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01575	REV: A0	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-01575		
PLOT NAME = Bottom Overlay	GENERATED : 1/25/2018 9:07:44 AM		TEXAS INSTRUMENTS





ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01575	REV: A0	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-01575		
PLOT NAME = Drill Drawing	GENERATED : 1/25/2018	9:07:44 AM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-01575	REV: A0	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-01575		
PLOT NAME = Board Dimensions	GENERATED : 1/25/2018 9:07:44 AM		TEXAS INSTRUMENTS

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